

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
LAWRENCE T. CLARK	03/14/2013
DAVID A. KIDD	03/14/2013
AUGUSTINE KUO	03/14/2013
RECEIVING PARTY DATA	
Name:	SUVOLTA, INC.
Street Address:	130 KNOWLES DRIVE
Internal Address:	SUITE D
City:	LOS GATOS
State/Country:	CALIFORNIA
Postal Code:	95032
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14799715
CORRESPONDENCE DATA	
Fax Number:	(214)661-4688
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	elody.tignor@bakerbotts.com
Correspondent Name:	BRADLEY P. WILLIAMS
Address Line 1:	2001 ROSS AVENUE SUITE 600
Address Line 2:	BAKER BOTTS LLP
Address Line 4:	DALLAS, TEXAS 75201
ATTORNEY DOCKET NUMBER:	083852.0343
NAME OF SUBMITTER:	ELODY TIGNOR
SIGNATURE:	/Elody Tignor/
DATE SIGNED:	11/23/2015
Total Attachments: 4	
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ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, said application having been executed on the date set forth below; and

WHEREAS, SUVOLTA, INC. (hereinafter referred to as "Assignee"), a Delaware corporation, with an address of 130 Knowles Drive, Suite D, Los Gatos, California 95032, desires to acquire my entire right, title and interest in and to the invention, and in and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I assign to Assignee, all right, title and interest in and to said invention and in and to said application and all patents which may be granted therefor, and all provisional, divisions, reissues, continuations, continuations-in-part and extensions thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patents resulting therefrom, insofar as my interest is concerned, to Assignee.

I also assign to Assignee, all right, title and interest to the invention disclosed in said application throughout the world, including the right to file applications and obtain patents, utility models, industrial models and designs for said invention in its own name throughout the world including all rights to publish cautionary notices reserving ownership of said invention and all rights to register said invention in appropriate registries; and I further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith necessary to perfect such right, title and interest in Assignee.

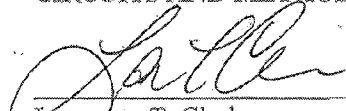
I will communicate to Assignee any facts known to me respecting any improvements; and, at the expense of Assignee, I will testify in any legal proceedings, sign all lawful papers, execute all provisional, divisional, continuation, continuation-in-part, reissue and substitute applications, make lawful oaths and declarations, and generally do everything possible to vest title in Assignee and to aid Assignee to obtain and enforce proper protection for said invention in all countries.

This Assignment shall be binding on the parties' successors, assigns and legal representatives.

Title of Invention:

INTEGRATED CIRCUIT DEVICE BODY BIAS
CIRCUITS AND METHODS

Signature of Inventor:
Full name of inventor:


Lawrence T. Clark

Residence:

Phoenix, Arizona 85048

Date:


3/14/13

Title of Invention:

INTEGRATED CIRCUIT DEVICE BODY BIAS
CIRCUITS AND METHODS

Signature of Inventor:

Full name of inventor:


David A. Kidd

Residence:

San Jose, California 95127

Date:


3/14/2013

Title of Invention:

INTEGRATED CIRCUIT DEVICE BODY BIAS
CIRCUITS AND METHODS

Signature of Inventor:

Full name of inventor:


Augustine Kuo

Residence:

Berkeley, California 94708

Date:

March 14, 2013